In The Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

- 1. (Original) A porous substrate, comprising a plurality of porous layers thereon, wherein the average opening diameter of pores in a porous layer of said plurality of porous layers positioned in an outermost surface is smaller than the average diameter of pores in a porous layer of said plurality of porous layers positioned on a substrate side relative to said porous layer positioned in said outermost surface.
 - 2. (Original) A porous substrate, comprising a plurality of porous layers thereon, wherein the average opening diameter of pores in a porous layer of said plurality of porous layers positioned in an outermost surface is smaller than the average diameter of pores in a porous layer of said plurality of porous layers positioned on a substrate side relative to said porous layer positioned in said outermost surface; and the volume porosity of said plurality of porous layers is 10%-90%.
 - 3. (Original) A porous substrate, comprising two porous layers thereon, wherein the average opening diameter of pores in a first porous layer of said two porous layers positioned in an outermost surface is smaller than the average diameter of pores in a second porous layer positioned on a substrate side relative to said first porous layer; and more than 50% of said pores in said first porous layer penetrate from the surface of said first porous layer to the interface between said first and second porous layer.
 - 4. (Original) A porous substrate, comprising two porous layers thereon, wherein the average opening diameter of pores in a first porous layer of said two porous layers positioned in an outermost surface is smaller than the average diameter of pores in a

second porous layer positioned on a substrate side relative to said first porous layer; more than 50% of said pores in said first porous layer penetrate from the surface of said first porous layer to the interface between said first and second porous layer; and the volume porosity of said first and second porous layer is 10%-90%.

- 5. (Original) The porous substrate according to claim 3, wherein said first porous layer comprises a metal material.
- 6. (Original) The porous substrate according to claim 3, wherein said first porous layer comprises a metal oxide, a metal nitride, or a metal carbide.
- 7. (Original) The porous substrate according to claim 3, wherein said second porous layer comprises a semiconductor material.
- 8. (Original) The porous substrate according to claim 3, wherein said second porous layer comprises a group III nitride series compound semiconductor material.
- 9. (Original) The porous substrate according to claim 3, wherein said first porous layer comprises TiN or Pt, and said second porous layer comprises GaN.
- 10. (Original) The porous substrate according to claim 3, wherein said average opening diameter of said porosity in said first porous layer is not more than 1 μm.
- 11. (Original) The porous substrate according to claim 3, wherein the film thickness of said first porous layer is not more than 1 μ m.
- 12. (Withdrawn) A fabrication method for a porous substrate, comprising growing two or more different material layers on a substrate, heating said each layer, and thereby forming two or more porous layers with pores therein.
- 13. (Original) A GaN series semiconductor layered substrate, comprising a GaN series semiconductor layer grown on a porous substrate defined claim 1.

- 14. (Withdrawn) A fabrication method for a GaN series semiconductor layered substrate, comprising growing two or more different material layers on a substrate, heating said each layer, thereby forming a porous substrate with two or more porous layers having pores therein, and growing a GaN semiconductor layer on that porous substrate.
- 15. (Original) A GaN series semiconductor layered substrate, comprising a GaN series semiconductor layer grown on a porous substrate defined in claim 2.
- 16. (Withdrawn) A GaN series semiconductor layered substrate, comprising a GaN series semiconductor layer grown on a porous substrate defined in claim 3.
- 17. (Original) A GaN series semiconductor layered substrate, comprising a GaN series semiconductor layer grown on a porous substrate defined in claim 4.